DATASHEET

4 PIN DIP ZERO-CROSS TRIAC DRIVER PHOTOCOUPLER ELT304X, ELT306X, ELT308X Series



Features:

- Peak breakdown voltage
 - 400V: ELT304X
 - 600V: ELT306X
 - 800V: ELT308X
- High isolation voltage between input and output (Viso=5000 V rms)
- Zero voltage crossing
- Pb free and RoHS compliant.
- UL and cUL approved(No. E214129)
- VDE approved (No. 40028391)
- SEMKO approved
- NEMKO approved
- DEMKO approved
- FIMKO approved

Description

The ELT304X, ELT306X and ELT308X series of devices each consist of a GaAs infrared emitting diode optically coupled to a monolithic silicon zero voltage crossing photo triac.

They are designed for use with a discrete power triac in the interface of logic systems to equipment powered from 110 to 380 VAC lines, such as solid-state relays, industrial controls, motors, solenoids and consumer appliances.

Applications

- Solenoid/valve controls
- Light controls
- Static power switch
- AC motor drivers
- E.M. contactors
- Temperature controls
- AC Motor starters

Schematic



Pin Configuration

- 1. Anode
- 2. Cathode
- 3. Terminal
- 4. Terminal

Absolute Maximum Ratings (Ta=25℃)

	Parameter		Symbol	Rating	Unit
Input	Forward current		I _F	60	mA
	Reverse voltage		V _R	6	V
	Power dissipation		P _D	100	mW
Output		ELT304X		400	
	Off-state Output Terminal Voltage	ELT306X	V _{DRM}	600	V
		ELT308X		800	-
	Peak Repetitive Surge	Current	I _{TSM}	1	А
	Power dissipation		P _C	300	mW
Total pow	ver dissipation		P _{TOT}	330	mW
Isolation voltage ^{*1}			V _{ISO}	5000	Vrms
Operating temperature			T _{OPR}	-55 to 100	°C
Storage temperature			T _{STG}	-55 to 125	°C
Soldering Temperature* ²			T _{SOL}	260	°C

Notes:

*1 AC for 1 minute, R.H.= 40 ~ 60% R.H. In this test, pins 1 & 2 are shorted together, and pins 3 & 4 are shorted together. *2 For 10 seconds

Electro-Optical Characteristics (Ta=25°C unless specified otherwise)

Input							
Parameter		Symbol	Min.	Тур.*	Max.	Unit	Condition
Forward Voltage	Forward Voltage		-	-	1.5	V	I _F = 30mA
Reverse Leakag	e current	I _R	-	-	10	μA	$V_R = 6V$
Output							
Parame	eter	Symbol	Min.	Тур.*	Max.	Unit	Condition
Peak Blocking	ELT304X				100		V – Potod V
Current	ELT306X ELT308X	I _{DRM}	-	-	500	nA	$V_{DRM} = Rated V_{DRM}$ $I_F = 0mA$
Peak On-state V	/oltage	V_{TM}	-	-	3	V	I _{TM} =100mA peak, I _F =Rated I _{FT}
Critical Rate of	ELT304X ELT306X	1 / 1/	1000	-	-	V/µs	V_{PEAK} =Rated V_{DRM} , I _F =0 (Fig. 10)
Rise off-state Voltage	ELT308X	- dv/dt ·	600	-	-		
Inhibit Voltage (MT1-MT2 voltage above which device will not trigger)		V _{INH}	-	-	20	V	I_{F} = Rated I_{FT}
	Leakage in Inhibited State		-	-	500	μA	I _F = Rated I _{FT} , V _{DRM} =Rated V _{DRM} , off state
Transfer Chara	acteristics						
Parame	eter	Symbol	Min.	Typ.*	Max.	Unit	Condition
	ELT3041 ELT3061 ELT3081		-	-	15		
LED Trigger Current	ELT3042 ELT3062 ELT3082	I _{FT}	-	-	10	mA	Main terminal Voltage=3V
	ELT3043 ELT3063 ELT3083		-	-	5		
Holding Current		I _H	-	280	-	μA	

* Typical values at T_a = 25°C

Typical Electro-Optical Characteristics Curves









Figure 4. LED Current Required to Trigger vs. LED Pulse Width











Figure 10. Static dv/dt Test Circuit & Waveform



Measurement Method

The high voltage pulse is set to the required V_{PEAK} value and applied to the D.U.T. output side through the RC circuit above. LED current is not applied. The waveform V_T is monitored using a x100 scope probe. By varying R_{TEST} , the dv/dt (slope) is increased, until the D.U.T. is observed to trigger (waveform collapses). The dv/dt is then decreased until the D.U.T. stops triggering. At this point, τ_{RC} is recorded and the dv/dt calculated.

$$dv/dt = \frac{0.632 \text{ x } V_{\text{PEAK}}}{\tau_{\text{RC}}}$$

For example, V_{PEAK} = 600V for ELT306X series. The dv/dt value is calculated as follows:

$$dv/dt = \frac{0.63 \times 600}{\tau_{RC}} = \frac{378}{\tau_{RC}}$$

Order Information

Part Number

ELT304X(Y)(Z)-V or ELT306X(Y)(Z)-V or ELT308X(Y)(Z)-V

Note

Note

X = Part No. (1, 2, or 3)

Y = Lead form option (S, S1, M or none)

Z = Tape and reel option (TA, TB, TU, TD or none).

V = VDE safety approved option

Option	Description	Packing quantity
None	Standard DIP-4	100 units per tube
М	Wide lead bend (0.4 inch spacing)	100 units per tube
S (TA)	Surface mount lead form + TA tape & reel option	1000 units per reel
S (TB)	Surface mount lead form + TB tape & reel option	1000 units per reel
S1 (TA)	Surface mount lead form (low profile) + TA tape & reel option	1000 units per reel
S1 (TB)	Surface mount lead form (low profile) + TB tape & reel option	1000 units per reel
S (TU)	Surface mount lead form + TU tape & reel option	1500 units per reel
S (TD)	Surface mount lead form + TD tape & reel option	1500 units per reel
S1 (TU)	Surface mount lead form (low profile) + TU tape & reel option	1500 units per reel
S1 (TD)	Surface mount lead form (low profile) + TD tape & reel option	1500 units per reel

Package Dimension (Dimensions in mm)

Standard DIP Type





Option M Type





Option S Type







Option S1 Type







Recommended pad layout for surface mount leadform



Device Marking



Notes

EL	denotes Everlight
T3083	denotes Device Number
Y	denotes 1 digit Year code
WW	denotes 2 digit Week code
V	denotes VDE option

Tape & Reel Packing Specifications



EVERLIGHT

Tape dimensions



Dimension No.	Α	В	Do	D1	E	F
Dimension (mm)	10.5±0.1	4.65±0.1	1.55±0.1	1.50±0.1	1.75±0.1	7.5±0.1

Dimension No.	Ро	P1	P2	t	W	К
Dimension (mm)	4.0±0.1	12.0±0.1	2.0±0.1	0.35±0.1	16.0±0.3	4.75±0.1

Option TD

Option TU



Tape dimensions



Dimension No.	Α	В	С	D	E	F
Dimension(mm)	16.00±0.3	7.5±0.1	1.75±0.1	8.0±0.1	2.0±0.1	4.0±0.1
Dimension No.	G	Н	I	J	к	L
Dimension(mm)	1.55±0.05	10.4±0.1	0.4±0.05	4.60±0.1	5.1±0.1	1.55±0.05

Precautions for Use

1. Soldering Condition

1.1 (A) Maximum Body Case Temperature Profile for evaluation of Reflow Profile



Note:

Preheat

Temperature min (T _{smin})	150 °C
Temperature max (T _{smax})	200°C
Time (T_{smin} to T_{smax}) (t_s) Average ramp-up rate (T_{smax} to T_p)	60-120 seconds 3 °C/second max
Other	
Liquidus Temperature (T_L)	217 °C
Time above Liquidus Temperature (t $_{L}$)	60-100 sec
Peak Temperature (T _P)	260°C
Time within 5 °C of Actual Peak Temperature: T_P - 5°C	30 s
Ramp- Down Rate from Peak Temperature	6°C /second max.
Time 25°C to peak temperature Reflow times	8 minutes max. 3 times

Reference: IPC/JEDEC J-STD-020D

EVERLIGHT

DISCLAIMER

- 1. Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.
- 2. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
- 3. These specification sheets include materials protected under copyright of EVERLIGHT corporation. Please don't reproduce or cause anyone to reproduce them without EVERLIGHT's consent.